

CRMFGH1010A

N-Channel 100V, 10.5mΩ Typ. Power MOSFET

Description

Features

• 100V, 40A

 $R_{DS(ON)}$ Typ = 10.5m Ω @ V_{GS} = 10V

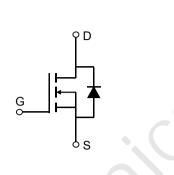
- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

PWM Application

• Power Management

· Load Switch



Schematic Diagram



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMFGH1010A	CRMFGH1010A	TO-220F-3L	TUBE	50	1000	5000

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Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	40	А
I _D		T _C = 100°C	24	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		160	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		76	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	37	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾		72	°C/W
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance, Junction to Case		3.3	°C/W
Τ _J , Τ _{stg}	Junction & Storage Temperature Range)	-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.4	2.8	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	V _{GS} = 10V, I _D = 30A	-	10.5	13.6	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	1195	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 50V, f = 1MHz	-	558	-	pF
C _{rss}	Reverse Transfer Capacitance		Χ-	10	-	pF
Q _g	Total Gate Charge	(_	28	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 50V, I_{D} = 20A$	9.	4.9	-	nC
Q_gd	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v, v_{\rm D} = 20 A$	-	7	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	13.5	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 50V	-	17	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 6 Ω	-	30	-	ns
t _f	Turn-Off Fall Time		-	18	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _s	Maximum Continuous Drain to Source Diode Forward Current		-	-	40	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	160	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	50	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 20A, di/dt = 100A/us	-	80	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=25ohm, L=0.5mH, I_{AS}=17.5A

3. R_{BJA} is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB

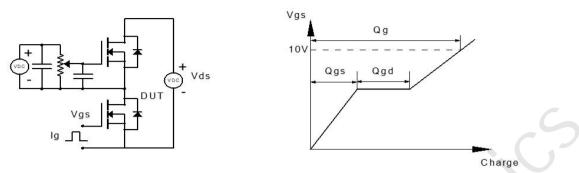
4. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

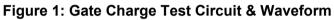


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Test Circuit





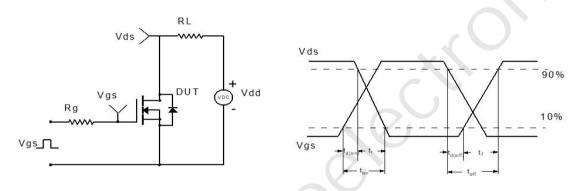
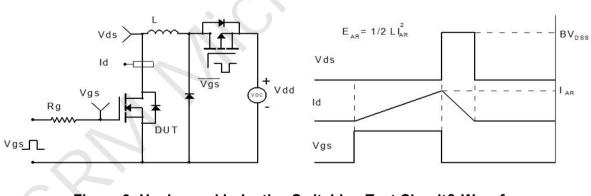
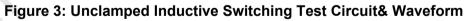


Figure 2: Resistive Switching Test Circuit & Waveform





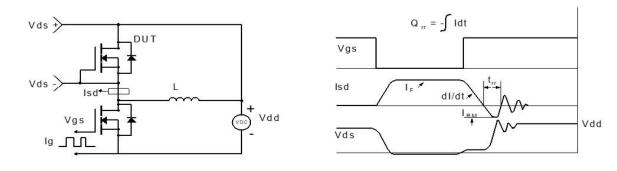
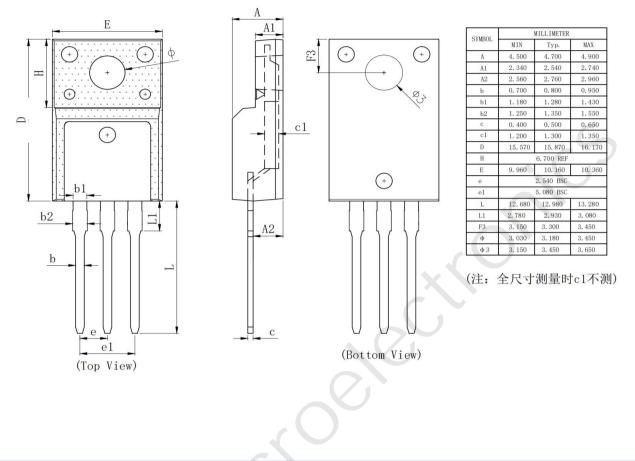


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-220F-3L)



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